

TAOGLAS. SXP.25.4.A.08



Datasheet

SXP.25.4.A.08

Part No: SXP.25.4.A.08

Description:

2320 ~ 2345 MHz SDARS 25mm Patch Antenna (Satellite Digital Audio Radio System)

Features:

25*25*4mm Terrablast Patch Antenna Excellent Efficiency: >75% High Gain (Up to 9.2 dBiC at Zenith) Excellent Impact Resistance Ultra-Lightweight @ 5.6g Optimized LHCP Radiation Pattern Pin & Adhesive Mounting Manufactured in an IATF16949 Approved Facilit RoHS & REACH Compliant

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1. Introduction



The Taoglas SXP.25.4.A.08 is part of a series of patch antennas designed for use with Satellite Digital Audio Radio Services (SDARS). It features left-hand circular polarization, low in-band axial ratio, and excellent gain characteristics in the 2320 to 2345 MHz band, making it compatible with the most popular satellite radio services available in many new vehicles.

SXP.25 comes in a convenient, compact form factor, with dimensions of 25mm x 25mm x 4mm. It is manufactured using Taoglas' patent pending Terrablast antenna technology, resulting in an ultra-lightweight patch that is 30% lighter than standard ceramic patches with ultra-impact resistant characteristics.

For further optimization to customer-specific device environments, custom tuned patch antennas can be supplied. Your regional Taoglas sales office can help you identify the best patch antenna for your specific SDARS application.



2. Specifications

	Electrical
Frequency	SIRIUS : 2326.25 MHz ± 6.25 MHz
requercy	XM : 2338.75 MHz ± 6.25 MHz
Centre Frequency	2332.5 MHz ± 12.5 MHz
Return Loss	SIRIUS: -10 dB max.
	XM: -10 dB max.
Zenith Gain	SIRIUS: +9 dBiC typ.
	XM: +9.2 dBiC typ.
Efficiency	SIRIUS: 78%
Avial Datia	42 @ Zonith
Axial Katio	
Polarization	LHCP
Impedance	50 Ω
	Mechanical
Dimensions	25 x 25 x 4mm
Pin Length	2.4mm
Pin Diameter	0.9mm
Weight	5.6g
	Environmental
Operation Temperature	-40°C to 85°C
Storage Temperature	-40°C to 85°C
Humidity	Non-condensing 65°C 95% RH
	Reliability
Low Temperature	-40°C, 24hrs
High Temperature	+85°C, 48hrs
Temperature Cycling	ISO16750 standard, total 240hrs
Temperature Step	ISO16750 standard, total 300mins
Drop Test	12m passed
Shock	10 shocks/ axis, 6 faces
Vibration	ISO16750 standard, 8 hours / axis
Pin pull force	>5kg-f

* Antenna properties were measured with the antenna mounted on 70*70mm Ground Plane



	XM Gain Requir	rements (Satellite) – Ground	Plane
AUT Location	Elevation Angle(degrees)	XM Sirius Limits(dBic)	Measured Average Gain(dBic)
	20≤φ≤25	0.5	2.4
	25≤φ≤30	1	3.4
Passive Ground Plane	30≤ф≤50	2	4.7
	50≤φ≤70	4	6.9
	70≤φ≤90	2	8.1

XM Gain Requirements (Terrestrial) – Ground Plane

AUT Location	Elevation Angle(degrees)	Antenna Mean Passive VP Gain Over Solid Angle (dBi)	Antenna P/P Gain variation (dB)
	0°≤φ≤10°	-3.1dBi	-
Passive Ground Plane	Ф=5°	-	2326.25MHz=1.6 dBic 2338.75MHz=1.3 dBic







3.



3.3 Average Gain



3.4 Peak Gain















4.1 Test Setup





2326.25MHz

2338.75MHz









NOTES:

- 1. Double sided adhesive area.
- 2. Soldermask area
- 3. "*" Critical Dimensions.

	Name	P/N	Material	Finish	QTY
1	SXP.25 Patch	013D136000J012	Terrablast	Clear	1
2	Double Sided Adhesive	013D136000J012	NITTO 5015	White Liner	1

5.



Footprint



Tolerance: +/- 0,20 Unit:mm



Soldering Recommendations



7.

Automated Ferrochrome Soldering Machine

Soldering Temperature: 360-380°C Soldering Duration: 3~4 seconds



7.2

Automated Ferrochrome Soldering Machine

Soldering Temperature: 360-380°C Soldering Duration: 3~4 seconds



Please note that this process will require a one-time fixture to be made for each PCB design.









Changelog for the datasheet

SPE-18-8-081- SXP.25.4.A.08

Revision: D (Current	t Version)
Date:	2023-04-11
Changes:	Updated Drawing
Changes Made by:	Cesar Sousa

Previous Revisions

Revision: C	
Date:	2021-06-21
Changes:	Updated Pin Length to 2.4mm Updated Drawing
Changes Made by:	Gary West

Revision: B

Date:	2020-09-12
Changes:	Amended soldering recommendations and updated to new datasheet format.
Changes Made by:	Gary West

Revision: A (Original First Release)		
	Date:	2018-23-08
Cł	hanges:	
Changes Ma	1ade by:	тн

